Reaction-assisted diffusion bonding of Ti-6Al-4V to Al₂O₃

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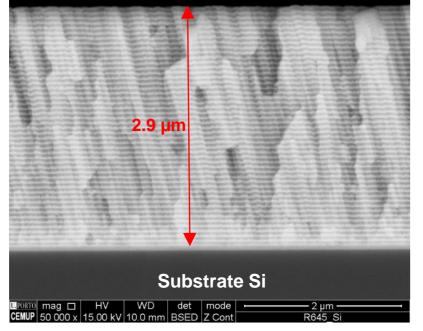


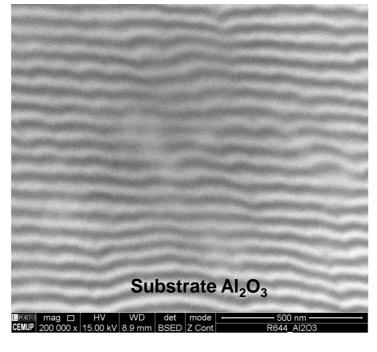
Objective

Diffusion bonding is one of the most suitable processes for producing joints with microstructural and mechanical soundness. This work aims at investigating joining of Ti-6Al-4V to Al_2O_3 using Ni/Ti reactive multilayer thin films (alternated Ni and Ti nanolayers) deposited by magnetron sputtering onto the base materials. Due to their exothermic and nanometric character, these multilayers might improve the diffusion bonding process between these dissimilar materials.

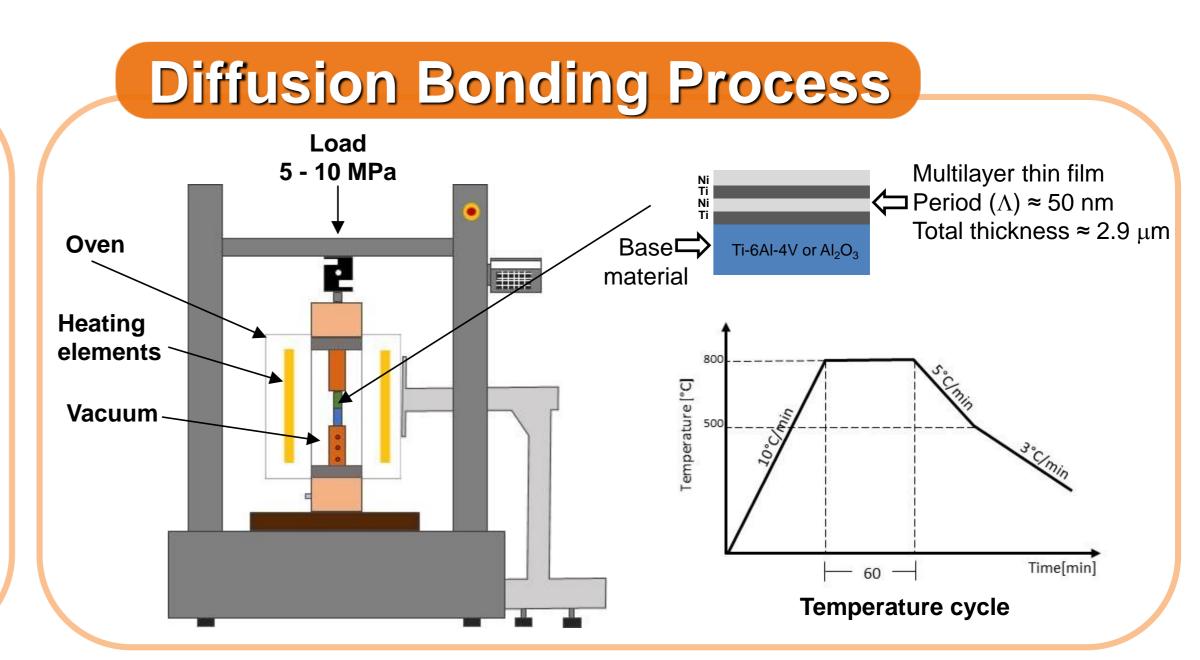
Depositions by Magnetron Sputtering





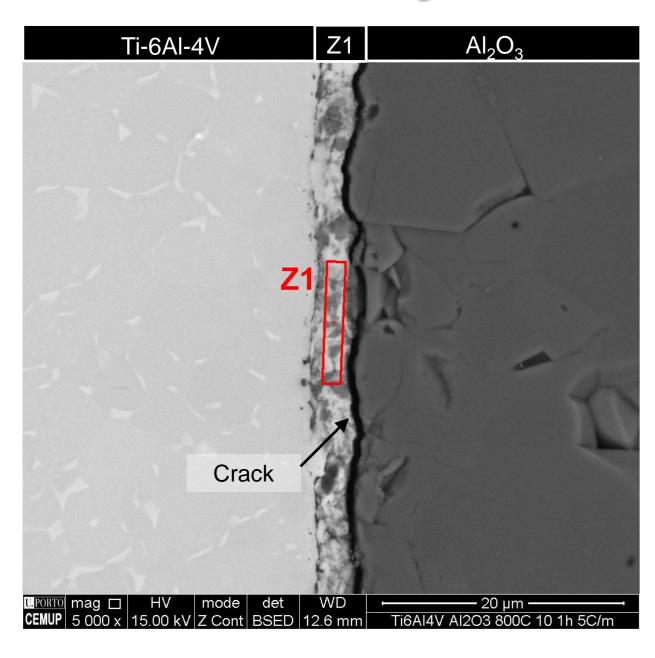


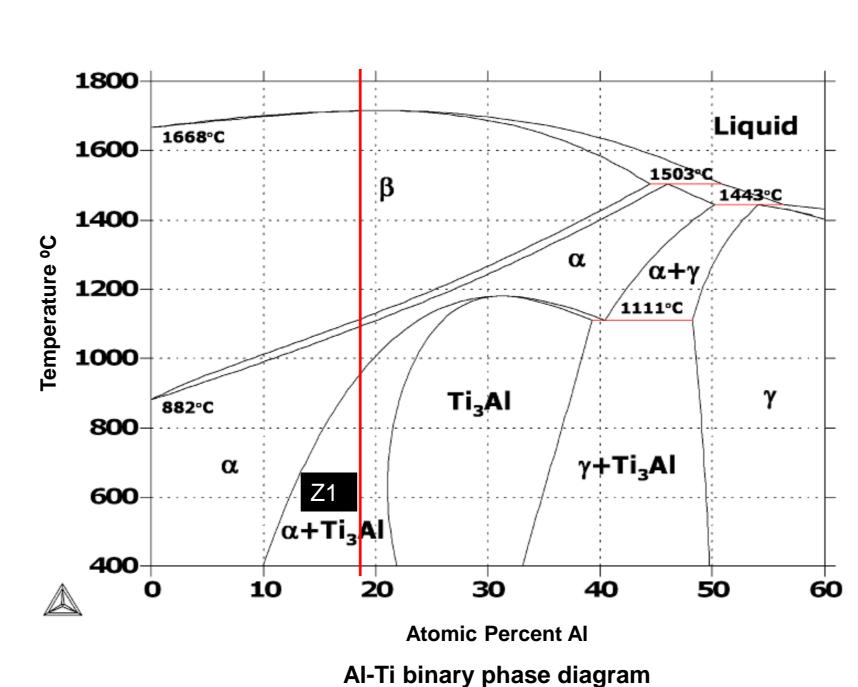
Ni/Ti reactive multilayer thin film $\Lambda \approx 50$ nm



Results and Discussion

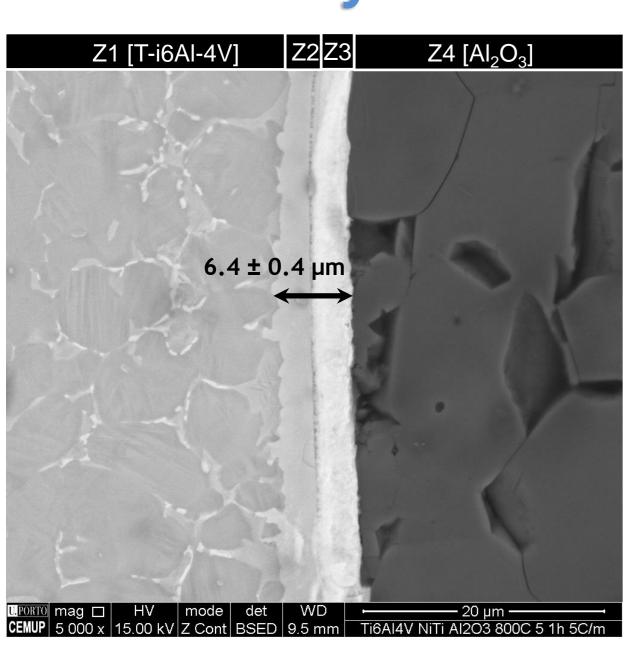
Without multilayers

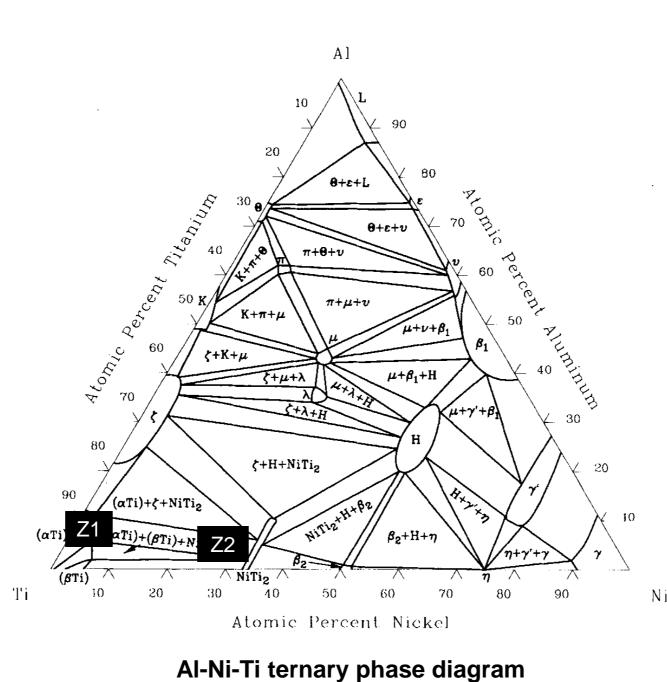




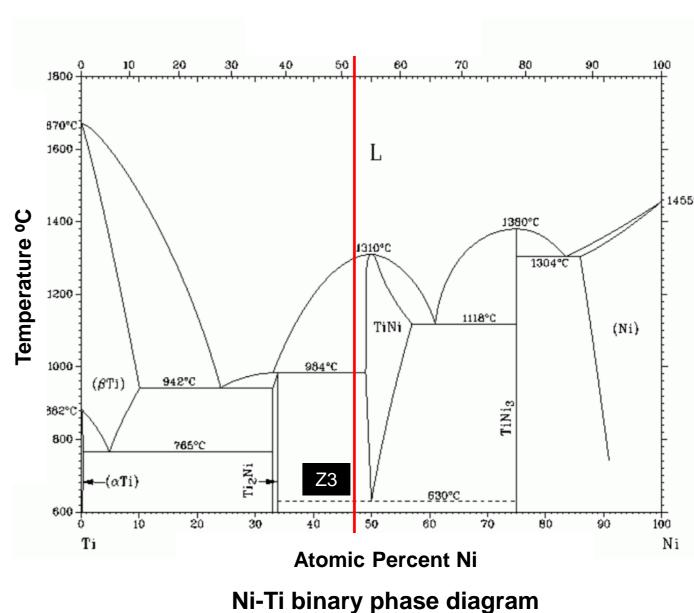
- Diffusion bonding was carried out at 800° C, 60 min and 5 MPa, without multilayers
- Cracks can be observed throughout the interface
- Possible phases at the interface : α -Ti and Ti₃Al

Ni/Ti multilayers









ightharpoonup Ti-6Al-4V was diffusion bonded to Al₂O₃ at 800° C, 60 min and 5 MPa, using Ni/Ti multilayer thin films

800°C isothermal

- Interface without pores or cracks
- Nossible phases composing the interface: Z1 Ti (α) + Ti (β) , Z2 NiTi₂, Z3 NiTi

Conclusions

The main goal of this study is to obtain sound joints between Ti-6Al-4V and Al_2O_3 using the diffusion bonding process assisted by reactive multilayer thin films. The use of Ni/Ti multilayers with 50 nm period improves the quality of the joint interface. However, brittle intermetallic compounds are formed at the interface region.

ACKNOWLEDGEMENTS







